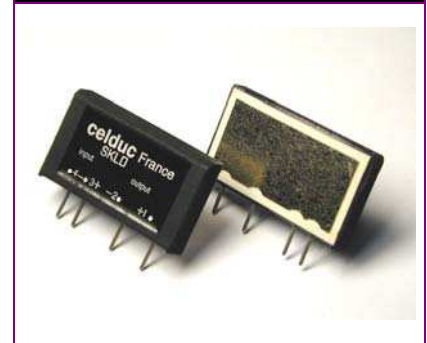


MOSFET BASED DC SOLID STATE RELAY

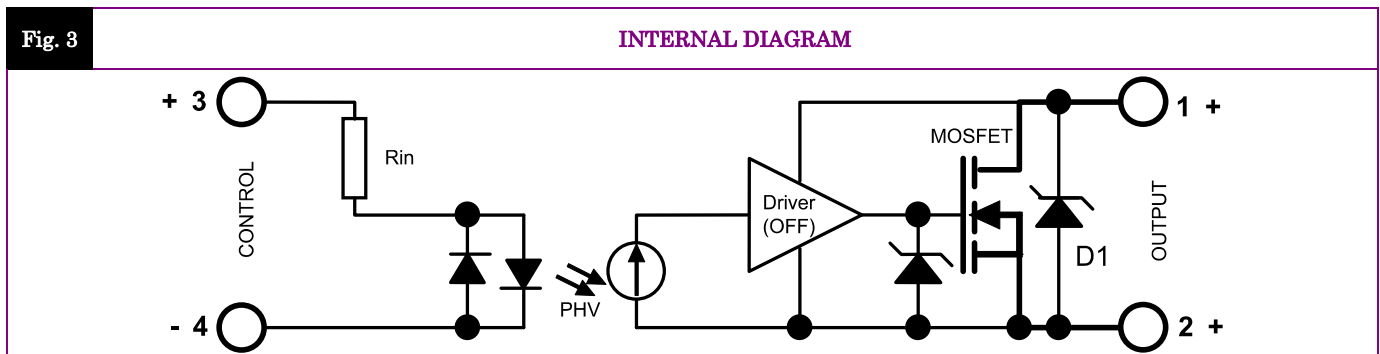
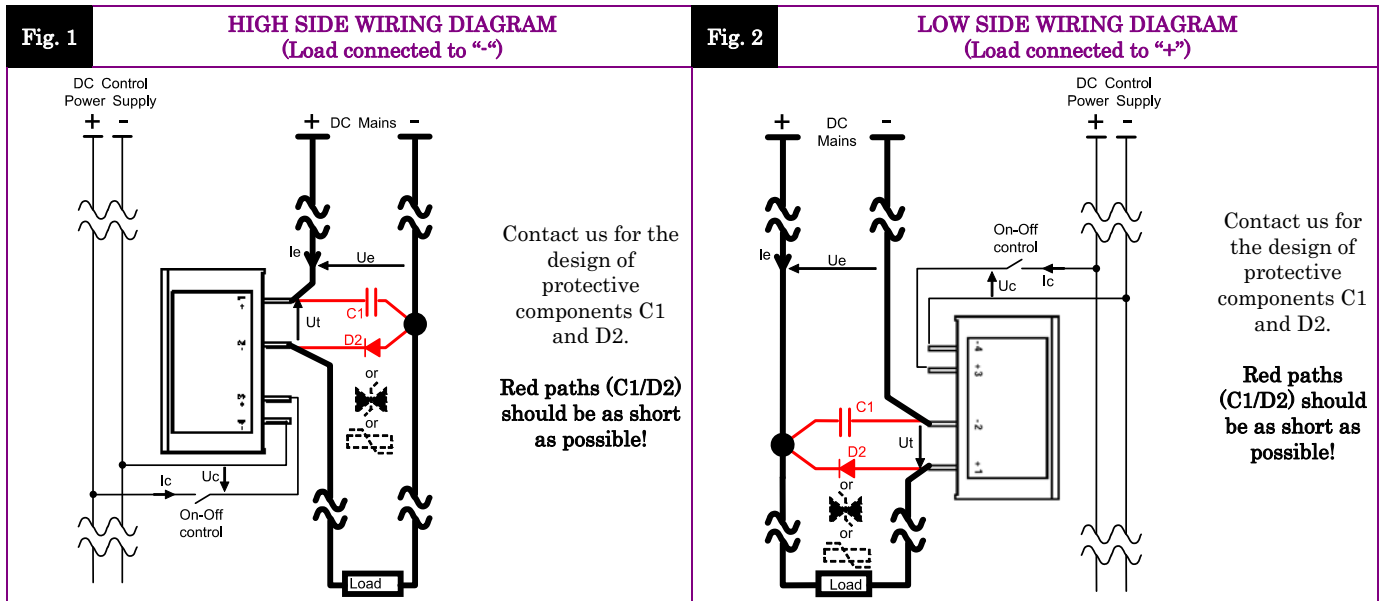
- ▶ For PCB or standard sockets
- ▶ Latest MOSFET technology generation.
- ▶ Ultra low on-state resistance.
- ▶ Built-in overvoltage protection (transil diode)
- ▶ Low control current consumption
- ▶ Applications :
 - Traffic lights
 - Small motors, electromagnets, lights, heaters
 - Measurement products
 - ...

SKLD30520



Control voltage range	18-32VDC
Max output peak voltage	200VDC
Nom. load current without heatsink	8ADC

Load voltage range	Load current range	Control input voltage range	In & case / Out Insulation	Connections	Dimensions (WxHxD in mm)	Weight
12-100VDC	0 to 8A <small>(more with a heatsink)</small>	18-32VDC	2.5kV	Terminals for PCB or standard sockets	43.6 x 24.5 x 6.3 <small>(housing)</small>	15g



Proud to serve you

CONTROL INPUT CHARACTERISTICS

INPUT CIRCUIT	CHARACTERISTIC	LABEL	VALUE	INFO.
	Nominal control voltage	Ucnom	24VDC	
	Nominal control current	Icnom	21mADC	
	Control voltage range	Uc	18 – 32VDC	
	Current consumption	Ic	15 – 30mADC for control voltage range	See fig. 5
	Releasing voltage	Ucoffmax	1VDC	
	Max. reverse voltage	-Uemax	32VDC	
	Input impedance	Rin	1000 Ω	See fig. 5

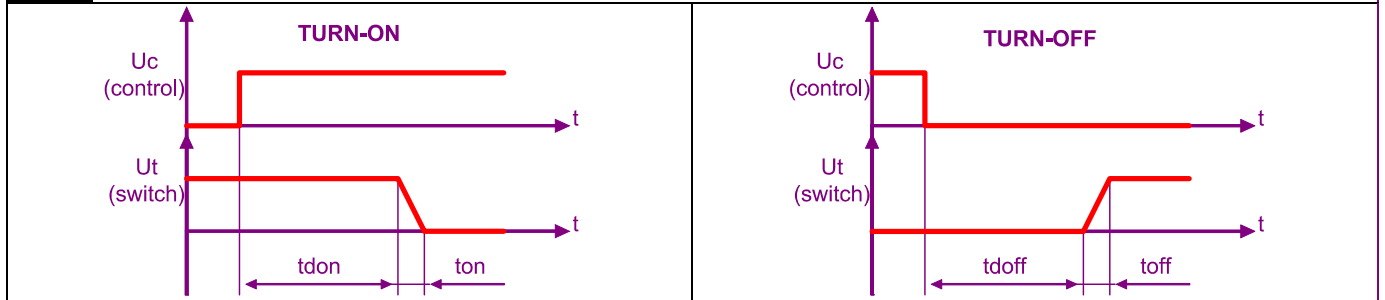
POWER OUTPUT CHARACTERISTICS

POWER CIRCUIT	CHARACTERISTIC	LABEL	VALUE	INFO.	
	Mains Nominal voltage	Uenom	12-24-48-96VDC		
	Mains voltage range	Ue	10-100VDC		
	Non-repetitive peak voltage	Uep	200V		
	Overvoltage protection	D1	100V@1mA 137V@11A	See Instruction sheet for selective the right protective components	
	Reverse voltage (internal diode)	-Ue	1,3V	@Ie=50A @Uc=0	
	Max. repetitive avalanche current	Iep	68A	Pulse width limited by Tj max	
	Max. single pulse avalanche energy	Eep	250mJ	@Tj=25°C @Iep=37A	
	Max. repetitive pulse avalanche energy	Eep	950mJ	@Tj=25°C @Iep=8.2A	
	Maximum nominal currents	Ie	Resistive	Please consult us	See fig. 7 for limits
			8A (without heatsink)		
	Non-repetitive peak overload current	Iepeak	142A		See fig. 8
	Min. load current	Iemin	0.1mA		
	Max. leakage current	Ielk	20μADC		@Ue=200V
	Max. on-state resistance	RDSon	44mΩ		@Iemax @Tjmax
			18.6 mΩ		@25°C
	Typ. output capacitance	Cout	410pF		
	Junction/case thermal resistance per power element	Rthjc	0.4K/W		Total = 1 power elements
	Relay/ambient thermal resistance vertically mounted	Rthra	26K/W		@ΔTra=80°C
	Relay thermal time constant	Tthra	3min		@ΔTra=80°C
	Control inputs/power outputs insulation voltage	Uimp	2.5kV		
	Inputs/case insulation voltage	Uimp	2.5kV		
	Outputs/case insulation voltage	Uimp	2.5kV		
	Isolation resistance	Rio	1GΩ		
	Isolation capacitance	Cio	<8pF		
	Maximum junction temperature	Tjmax	175°C		
	Storage ambient temperature	Tstg	-40->+100°C		
	Operating ambient temperature	Tamb	-40->+90°C		See fig. 7
	Max. case temperature	Tc	100°C		

TIME CHARACTERISTICS

Fig. 4

TIME DIAGRAM



TIME CHARACT.	CHARACTERISTIC	LABEL	VALUE	INFO.
	Turn on time	ton	5μs	
	Turn on delay	tdon	10μs	
	Turn off time	toff	150μs	
	Turn off delay	tdoff	20μs	
Max. On-Off frequency	F(on-off)	100Hz		Please consult us for higher frequency

GENERAL INFORMATION

MISC.	Max connection soldering temperature		300°C 10s	
	Housing		UL94V0	
	Mounting		PCB : A special clip is necessary to attach a heatsink	See mounting sheet
	Noise level		No audible noise	
	Weight		15g	

STANDARDS

GENERAL	Standards		IEC60947-1	
	Protection level		IP00	
	Protection against direct touch		None	
	CE marking		Yes	
	UL, cULUS and VDE approvals		Pending	

E.M.C. IMMUNITY	TYPE OF TEST	STANDARD	LEVEL	EFFECT
	E.S.D. (Electrostatic discharges)	EN61000-4-2	Pending	?
	Radiated electromagnetic fields	EN61000-4-3	Pending	?
	Fast transients bursts	EN61000-4-4	4kV coupling by clamp on the input side and direct for power side	No effect
	Electric chocks	EN61000-4-5	1kV direct coupling on the input side (pending for power side)	?
Voltage drop	EN61000-4-11	-		

E.M.C. EMISSION	Radiated and conducted disturbances	NFEN55011	Pending	
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CHARACTERISTIC CURVES

Fig. 5

INPUT CHARACTERISTIC

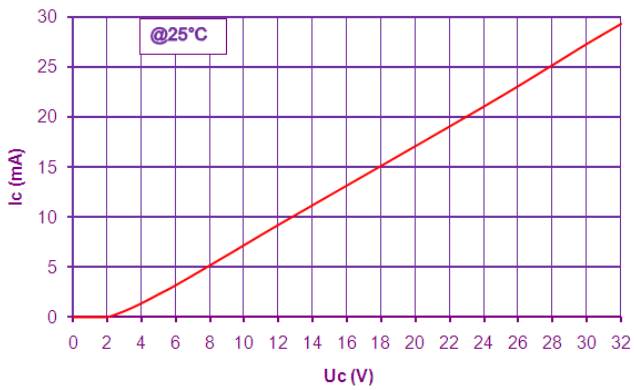


Fig. 6

ON RESISTANCE VS TEMPERATURE

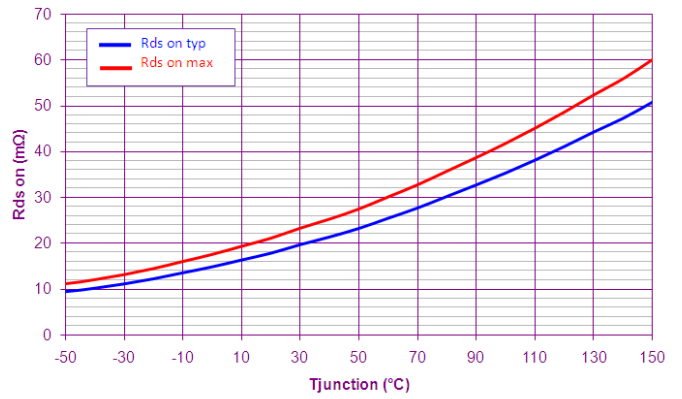


Fig. 7

POWER DISSIPATED AND LOAD CURRENT LIMIT VS TEMPERATURE

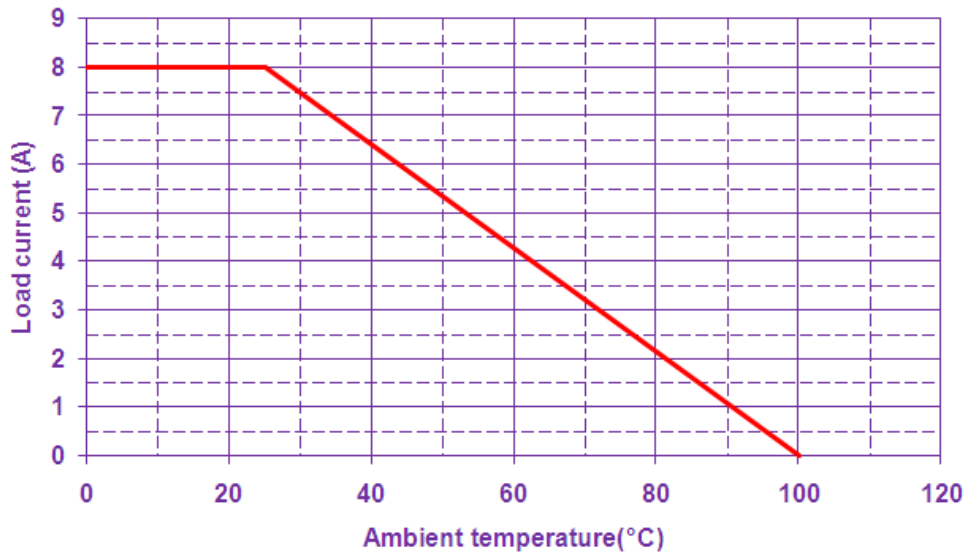
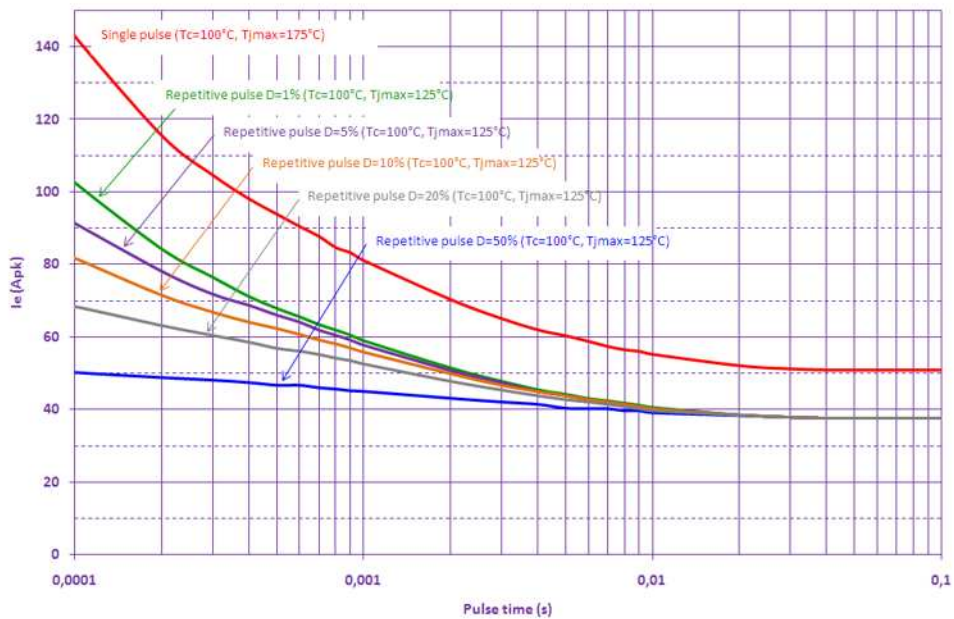


Fig. 8

CURRENT OVERLOAD CHARACTERISTIC (ITSM)



DIMENSIONS AND ACCESSORIES

Fig. 9

DIMENSIONS

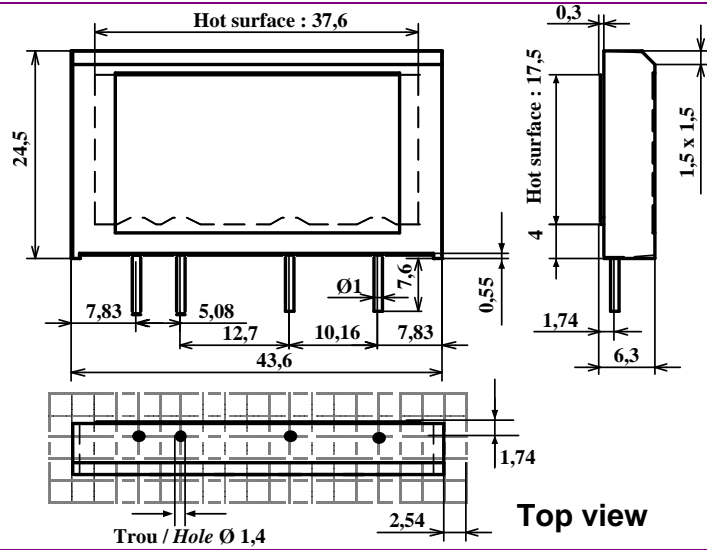


Fig. 10

ACCESSORIES

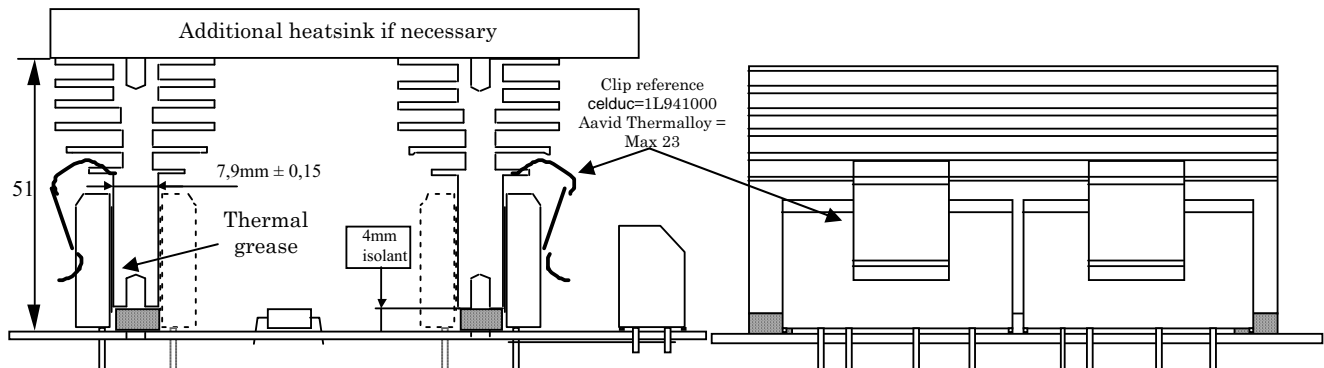
Heatsinks with mounting clips (Max Clip System^(*))

celduc heatsink references (equivalent to Aavid Thermalloy S507) :

WF042000 : L=100mm ; almost 4K/W (1SSR) without ventilation (3.6K/W with 4 SSR)

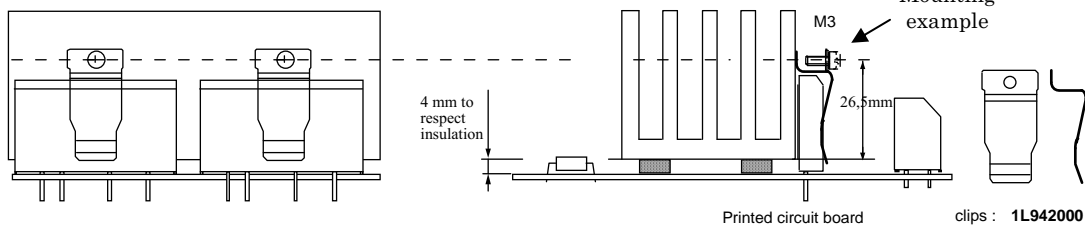
WF032000 : L=150mm ; almost 3K/W (1SSR) without ventilation (2.6K/W with 6 SSR)

Large range of heatsinks available on request.



^(*) Max Clip System of Aavid Thermalloy, patented worldwide (patent Nr9805561)

Standard heatsink mounting by clips with screws



4mm thick isolated washers can be placed like shown on figures to keep a sufficient insulation between input and output on the printed circuit board (the heatsink is conductive).

Please use thermal grease to ensure a good thermal contact between the SSR and the heatsink.